─NO. 8318──

Docket No. 0756-2306

9/11/03 Mollish

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

- 1 -

In re Patent Application of)	Art Unit: 2813
Taketomi ASAMI et al.)	Examiner: D. Blum
Serial No. 09/842,315)	CERTIFICATE OF MAILING
Filed: April 26, 2001)	I hereby certify that this correspondence is being deposited with The United States Postal Service with sufficient postage as First Class Mail in an envelope addressed to: Commissioner for Patents.
For: MANUFACTURING METHOD)	
FOR SEMICONDUCTOR)	P.Q. Box 1450, Alexandria, VA 22313-1450, on <u>5.12.2063</u>
DEVICE)	Tarray 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1

AMENDMENT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

In response to the Office Action dated February 13, 2003, please amend the above-identified application as follows:

IN THE CLAIMS:

Please amend claims 1-15 as follows:

DI

1. (Amended) A method for manufacturing a semiconductor device comprising:

the first step of forming a semiconductor film over a substrate;

the second step of forming a thin oxide film on a surface of the semiconductor film by applying water in which ozone is dissolved;

the third step of etching the semiconductor film to remove the thin oxide film and contaminant impurities on the surface of the semiconductor film by applying an etching solution while spinning the substrate; and

the fourth step of forming a gate insulating film in contact with the semiconductor film after the third step,

			PTO/SB/21 (08-00
		Application Number	09/842,315
TRANS	/IITTAL	Filing Date	April 26, 2001
FORM		First Named Inventor	Taketomi ASAMI et al.
		Group Art Unit	2813
(to be used for all correspo		Examiner Name	D. Blum
Total Number of Pages in This	Submission	Attorney Docket Number	0756-2306
ENCLOSURES (check all that apply)			
Fee Transmittal Form Fee Attached Amendment / Reply After Final Affidavits/declaration(s) Extension of Time Request Express Abandonment Re Information Disclosure State Certified Copy of Priority Document(s) Response to Missing Parts Incomplete Application Response to Missing Factories	(for an	tition and Power of y ang-related Papers to Convert to a small Application of Attorney, Revocation of Correspondence of Correspondence to Refund on the Correspondence of Correspondence of Correspondence of The Commissioner is	After Allowance Communication to Group Appeal Communication to Board of Appeals and Interferences Appeal Communication to Group (Appeal Notice, Brief, Reply Brief) Proprietary Information Status Letter Other Enclosures 1. 2. 3. 4. 5. 6. ereby authorized to charge any additional overpayments to Deposit Account No. 50-indepted and the property of docket number.
SIGNATURE OF APPLICANT, ATTORNEY, OR AGENT			
Firm or Individual name	Eric J. Robinson, Reg. No. 38,285 Robinson Intellectual Property Law Office, P.C. PMB 955 21010 Southbank Street Potomac Falls, VA 20165		
Signature	5.6		
Date	5-12-03		
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Signature	addum 1	Stamper	Date 5.12.2003
Burden Hour Statement: This form is estimated to take 0.2 hours to complete. Time will vary depending upon the needs of the individual case. Any comments on the amount of time you are required to complete this form should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, Washington, DC 20231. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Commissioner for Patents, Washington, DC 20231.			

This will acknowledge receipt of the following:

Transmittal Form (2 copies)

2. Amendment

3. Certificates of Mailing for each of the above

In re PATENT application of:

TAKETOMI ASAMI et al Serial No. 09/842,315 Filed: 04/26/2001 Due Date: 05/13/2003

For: MANUFACTURING METHOD FOR SEMICONDUCTOR DEVICE

Docket: 0756-2306



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